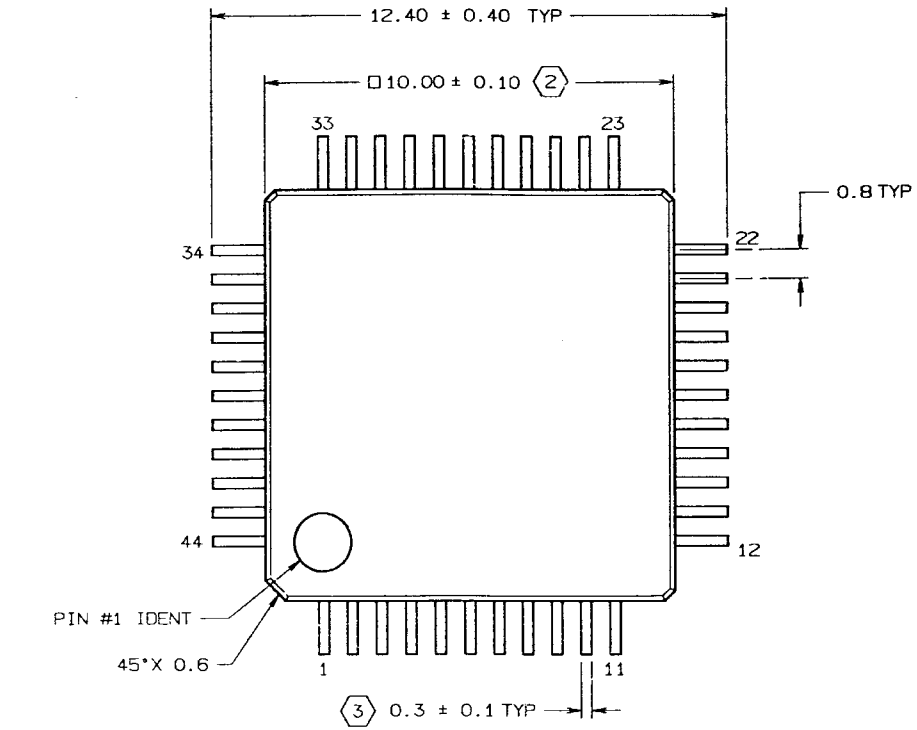
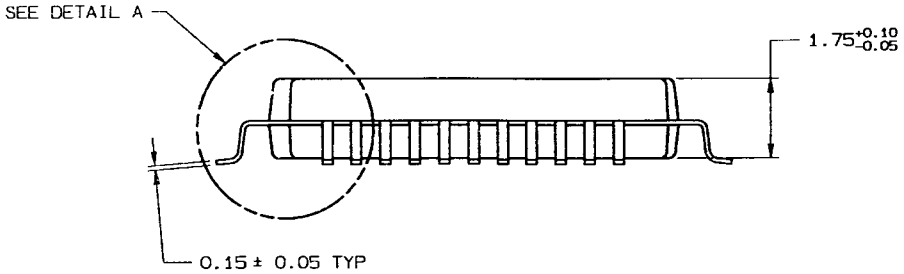
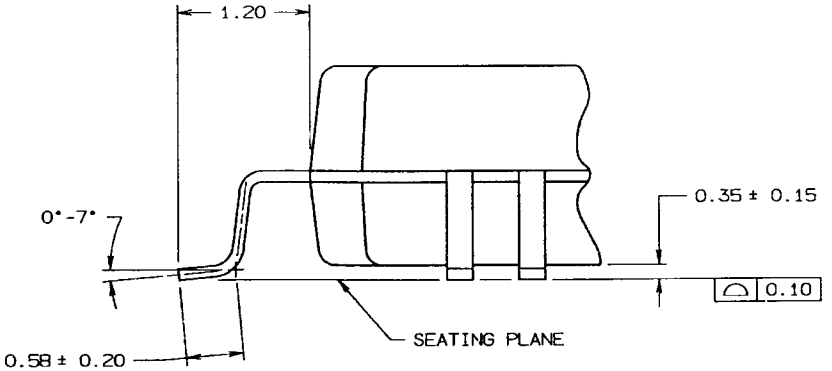
REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	09077	04/01/92	MS/







DETAIL A
TYPICAL

NOTES: UNLESS OTHERWISE SPECIFIED

1. STANDARD LEAD FINISH:
   5.08 MICROMETERS MINIMUM SOLDER PLATING (80/20)
   THICKNESS ON ALLOY 42 / COPPER.
2. DIMENSION DOES NOT INCLUDE MOLD PROTRUSION.
   MAXIMUM ALLOWABLE MOLD PROTRUSION 0.25 mm PER SIDE.
3. DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION.
   ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.15.

DIMENSIONS ARE IN MILLIMETERS

APPROVALS	DATE
DRAWN MARTA SUCHY	04/01/92
DFTG. CHK.	4/07/92
ENGR. CHK.	4/07/92
APPROVAL	

PROJECTION INCH [MM]

NATIONAL SEMICONDUCTOR CORPORATION
2900 Semiconductor Drive, Santa Clara, CA 95052-8090

PLASTIC QUAD FLATPACK, (S), 10 X 10 mm 44 LEAD

SCALE	SIZE	DRAWING NUMBER	REV
N/A	C	MKT-VEF44A	A

DO NOT SCALE DRAWING | SHEET 1 OF 1